

Enhancement Mode N-Channel Power MOSFET

SOP8/NMOS/30V/ \pm 20V/1.7V/8A/9.3m Ω

Rev0.5



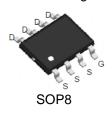


30V, 9.3mΩ, 8A, Single N-Channel

1.Features

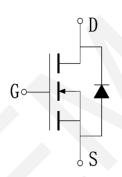
- ♦ 30V MOSFET technology
- ◆ Low on-state resistance
- ◆ Fast switching
- ♦ Vgs±20V

- ◆ Power Switching Application
- Load Switching



Pin Description

V_{DS}	R _{DS(on)} Typ.	I_D	
30V	9.3mΩ @ 10V	0.4	
	15mΩ @ 4.5V	8A	



Schematic Diagram

3. Package Marking and Ordering Information

Part no.	Marking	Package PCS/Tube		PCS/CTN.	
WP4406B	4406B	SOP8	4,000	48,000	

4. Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V _{DSS}	30	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	Ι _D	8	А
Drain Current (Pulse), PW≤300μs	I _{DM}	32	А
Total Dissipation	P _D	2.3	W
Avalanche Energy, Single Pulsed	E _{AS}	91.1	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T_{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



5. Thermal Resistance Ratings (Note 2)

Parameter	Symbol	Max.	Unit
Maximum Junction-to-Ambient	Reja	85	°C/W

Note 2: When mounted on 1 inch square copper board $t \le 10$ sec The value in any given application depends on the user's specific board design.

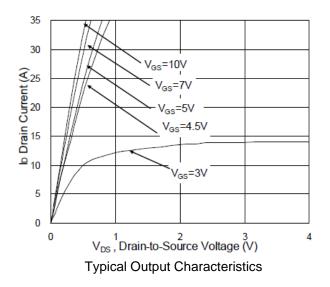
6.Electrical Characteristics at Ta=25°C (Note 3)

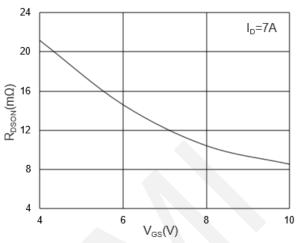
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \mu A$, $V_{GS} = 0 V$	30	33	-	V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μΑ
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	1	-	±100	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	V _{DS} =V _{GS} , I _{DS} =250µA	1.0	1.7	2.5	V
Static Drain to Source On-State	Б	I _D = 8A, V _{GS} = 10V		9.3	14	mΩ
Resistance	R _{DS(on)}	I _D = 6A, V _{GS} = 4.5V	1	15	19	mΩ
Input Capacitance	C _{iss}	V _{GS} =0V,	-	980	-	pF
Output Capacitance	Coss	V _{DS} =15V,	-	130	-	pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz	1	80	-	pF
Turn-ON Delay Time	t _{d(on)}	V _{DD} = 15V	ı	1.2	-	ns
Rise Time	tr	$V_{GS} = 10V$	-	40	-	ns
Turn-OFF Delay Time	$t_{d(off)}$	$R_{GEN} = 3.3\Omega$	-	18	-	ns
Fall Time	t _f	$I_D = 7A$	1	7.2	-	ns
	Qg	V _{DS} = 15V, V _{GS} = 4.5V,	-	6	-	nC
Total Gate Charge	Qgs		-	2.2	-	nC
	Q_{gd}	I _D = 7A	-	2	-	nC
Diode Forward Voltage	V _{FSD}	I _S = 8A, V _{GS} = 0V	-	0.85	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

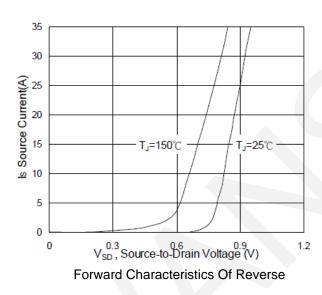


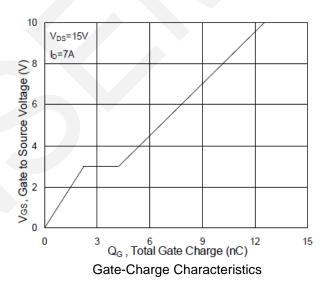
7. Typical electrical and thermal characteristics

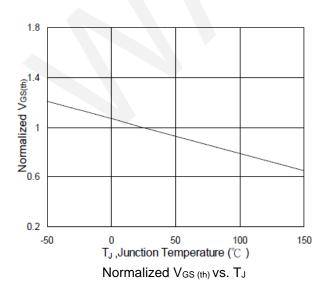


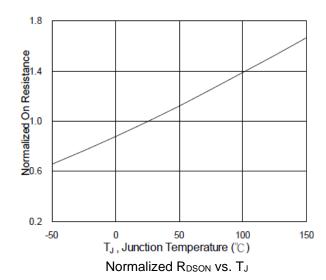


On-Resistance vs. Gate-Source Voltage

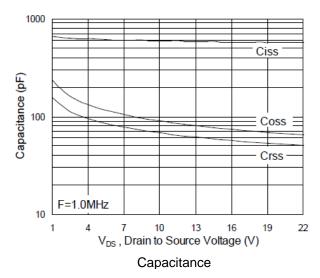


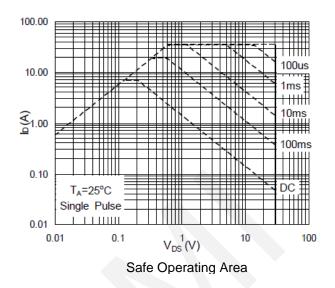


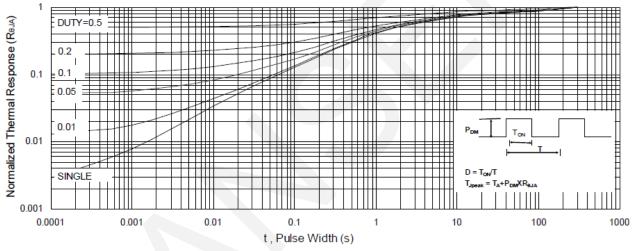








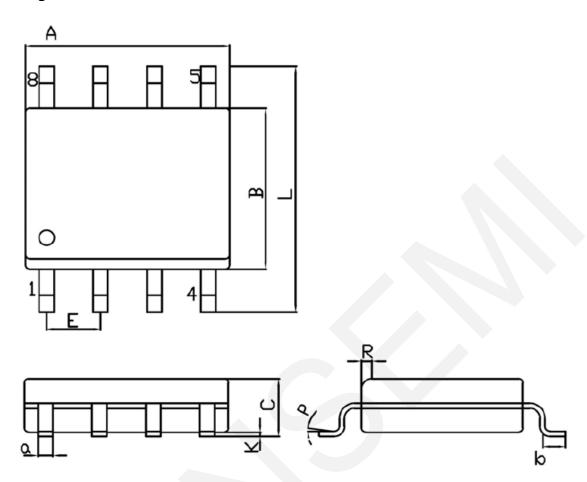




Normalized Maximum Transient Thermal Impedance



8.Package Dimensions



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters		
Symbol	Min	Max	Syribot	MIn	Max	
A	4.70	5,10	С	1,35	1.75	
В	3.70	4,10	۵	0,35	0.49	
L	5.80	6,20	R	0'30	0.60	
Ε	1.27BSC		Р	0+	7*	
K	0.12	0.22	b	0.40	1.25	



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